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of

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Application Number	10/673,476
Confirmation Number	1541
Filing Date	September 30, 2003
First Named Inventor	Kouzi HAYASI
Art Unit	2811
Examiner Name	Shouxiang HU
Attorney Docket Number	Q77787

## U.S. PATENT DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	Document Number		Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document
		Number	Kind Code <sup>2</sup> (if known)		
SP		US 6,069,404	A	05-30-2000	Aufinger et al.
SP		US 6,188,123	B1	02-13-2001	Tsakamoto
SP		US 5,965,930	A	10-12-1999	Sakamoto et al.
		US			
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## FOREIGN PATENT DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	Foreign Patent Document			Publication Date MM-DD-YYYY	Name of Patentee or Applicant of Cited Document	Translation <sup>6</sup>
		Country Code <sup>3</sup>	Number <sup>4</sup>	Kind Code <sup>5</sup> (if known)			
SP		JP	H10-163332	A	06-19-1998	Sony Corp.	ABS
SP		EP	0 395 862	A2	11-07-1990	Kabushiki Kaisha Toshiba	
SP		EP	1 061 572	A1	12-20-2000	STMicroelectronics S.r.l.	
SP		EP	0 382 504	A2	08-16-1990	Fujitsu Limited	

## NON PATENT LITERATURE DOCUMENTS

Examiner Initials*	Cite No. <sup>1</sup>	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume-issue number(s), publisher, city, and/or country where published.	Translation <sup>6</sup>
SP		N. Camilleri et al., "Bonding Pad Models for Silicon VLSI Technologies and Their Effects on the Noise Figure of RF NPNs", Microwave Symposium Digest, 1994, pages 1179-1182.	

Examiner Signature

Shouxiang Hu

Date Considered

3/21/05

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